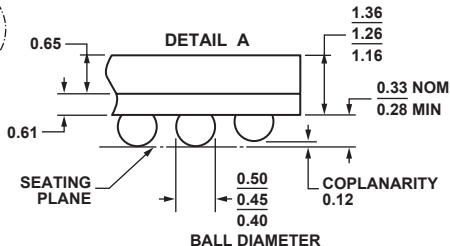
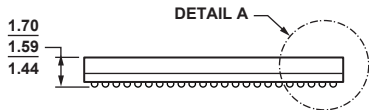
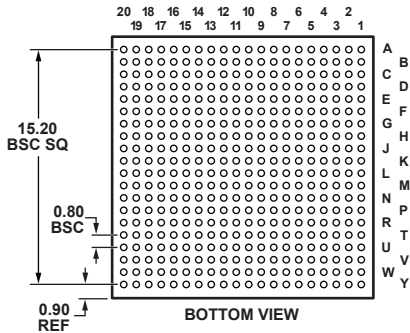
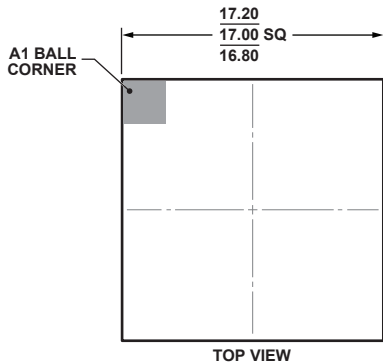


**400-Ball Chip Scale Package Ball Grid Array [CSP_BGA]
(BC-400-1)**

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-275-MMAB-1.